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(Rev. 03/ 01) OMB No. 0651-0027 (exp. 5/31/2002)	D 4 7 7 7 1 7	U.S. Patent and Trademark Office		
		Please record the attached original documents or copy thereof		
Name of conveying party(ies):		Name and address of receiving party(ies)		
Masaharu Tokuhara (12/05/2003), Toshio Sarugaku (12/05/2003), Naoki Kaneko (12/05/2003), and Seiko Imai (12/08/2003)		Name: Sony Corporation		
		Internal Address:		
		Street Address:		
Additional name(s) of conveying party(les) Stacked? Yes X No		7-35, Kitashinagawa 6-chome		
Nature of Conveyance:		Shinagawa-Ku ຶ		
X Assignment Merger		Tokyo 141-0001, Japan		
Security Agreement	Change of Name	City:		
Other	-	State: Zip:		
Execution Date: see B	lox 1, conveying parties	Additional name(s) & Yes X No address(es) attached:		
4. Application number(s) or	r patent number(s):			
If this document is being filed togo A. Patent Application No.(s 10/475,732		xecution date of the new application is: B. Patent No.(s):		
	Additional numbers attac	hed? Yes x No		
 Name and address of party to whom correspondence concerning document should be mailed: Name: Robert B. Cohen LERNER, DAVID, LITTENBERG, KRUMHOLZ & MENTLIK, LLP 		6. Total number of applications and patents involved:1		
		7. Total fee (37 CFR 3.41) \$ 40.00		
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ū	e and belief, the foregoing in document.	formation is true and sorrect and any attached copy		
Robert B. Cohen Name of Person Signing Signature Signature Date				
Total number of pages including cover sheet, attachments, and documents: 3				

PATENT REEL: 014607 FRAME: 0276

Docket Number: SONYJP-254

Sony Reference No.: S02P0521US00

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in:

VIDEO SIGNAL PROCESSING APPARATUS, VIDEO SIGNAL PROCESSING METHOD AND VIDEO SOURCE DETERMINING METHOD

for which an International Application was filed on April 23, 2002, PCT/JP02/04026, designating the United States;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35, Kitashinagawa 6-chome, Shinagawa-ku, Tokyo 141-0001, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I nereby authorize and request my attorney(s) of record in this application to insert the application number and filing date of this application in the spaces that follow: Application Number:, Filing Date:			
This assignment executed on the dates indicated l	below.		
Masaharu Tokuhara			
Name of First or Sole Inventor	Execution Date of U.S. Patent Application		
Kanagawa, Japan	•		
Residence of First or Sole Inventor	· · · · · · · · · · · · · · · · · · ·		
Marshown Tokuhowa	5/12/2003		
Signature of First or Sole Inventor	Date of this Assignment		

PATENT

REEL: 014607 FRAME: 0277

Docket Number: SONYJP-254

Sony Reference No. S02P0521US00

Toshio Sarugaku	
Name of Second Joint Inventor	Execution Date of U.S. Patent Application
Chiba, Japan	
Residence of Second Joint Inventor	
Toshio Sarugaku	December 5, 2003
Signature of Second Joint Inventor	Date of this Assignment
Naoki Kaneko	
Name of Third Joint Inventor	Execution Date of U.S. Patent Application
Kanagawa, Japan	
Residence of Third Joint Inventor	· · · · · · · · · · · · · · · · · · ·
Nacki Konako	5th/12/2003 Date of this Assignment
Signature of Third Joint Inventor	Date of this Assignment
Seiko Imai	·
Name of Fourth Joint Inventor	Execution Date of U.S. Patent Application
Chiba, Japan	,
Residence of Fourth Joint Inventor	······································
Seiko, Imai	8/12/2003
Signature of Fourth Joint Inventor	Date of this Assignment
Name of Fifth Joint Inventor	
THE OF I MAI JOING HIVEHIOL	Execution Date of U.S. Patent Application
Residence of Fifth Joint Inventor	· · · · · · · · · · · · · · · · · · ·
Signature of Fifth Joint Inventor	Date of this Assignment

PATENT REEL: 014607 FRAME: 0278